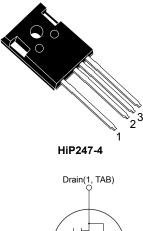
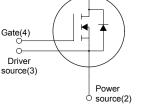
# SCTWA35N65G2V4AG



### Datasheet

# Automotive-grade silicon carbide Power MOSFET 650 V, 55 m $\Omega$ typ., 45 A in an HiP247-4 package





ND1TPS2DS3G4

## Features

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>
SCTWA35N65G2V4AG	650 V	67 mΩ	45 A

- AEC-Q101 qualified
- Very fast and robust intrinsic body diode
- Low capacitances
- Source sensing pin for increased efficiency
- Very high operating junction temperature capability (T<sub>J</sub> = 200 °C)

#### **Applications**

- Main inverter (electric traction)
- DC/DC converter for EV/HEV
- On board charger (OBC)

## Description

This silicon carbide Power MOSFET device has been developed using ST's advanced and innovative 2<sup>nd</sup> generation SiC MOSFET technology. The device features remarkably low on-resistance per unit area and very good switching performance. The variation of switching loss is almost independent of junction temperature.



#### Product status link SCTWA35N65G2V4AG

Product summary		
Order code	SCTWA35N65G2V4AG	
Marking	SCT35N65G2VAG	
Package	HiP247-4	
Packing	Tube	



# 1 Electrical ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	650	V
V <sub>GS</sub>	Gate-source voltage	-10 to 22	V
V GS	Gate-source voltage (recommended operating range)	-5 to 18	v
1-	Drain current (continuous) at T <sub>C</sub> = 25 °C	45	- A
Ι <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	35	A .
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	90	Α
P <sub>TOT</sub>	Total power dissipation at $T_C$ = 25 °C	240	W
T <sub>stg</sub>	Storage temperature range	-55 to 200	°C
TJ	Operating junction temperature range	-55 (0 200	°C

#### Table 1. Absolute maximum ratings

1. Pulse width is limited by safe operating area.

#### Table 2. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thJC</sub>	Thermal resistance, junction-to-case	0.72	°C/W
R <sub>thJA</sub>	Thermal resistance, junction-to-ambient	40	°C/W

# 2 Electrical characteristics

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(T<sub>C</sub> = 25 °C unless otherwise specified).

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS}$ = 0 V, I <sub>D</sub> = 1 mA	650			V
I <sub>DSS</sub>	Zero gate voltage drain current	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 650 V			5	μA
I <sub>GSS</sub>	Gate-body leakage current	$V_{DS}$ = 0 V, $V_{GS}$ = -10 to 22 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 1 \text{ mA}$	1.8	3.2	5	V
		V <sub>GS</sub> = 20 V, I <sub>D</sub> = 20 A		45	67	
R <sub>DS(on)</sub>	Static drain-source on-resistance	V <sub>GS</sub> = 18 V, I <sub>D</sub> = 20 A		55		mΩ
		$V_{GS}$ = 20 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 200 °C		68		

#### Table 3. On/off states

#### Table 4. Dynamic, based on HiP247 package option

Symbol	bol Parameter Test conditions		Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	1370	-	pF
C <sub>oss</sub>	Output capacitance $V_{GS}$ = 0 V, $V_{DS}$ = 400 V, f = 1 MHz		-	125	-	pF
C <sub>rss</sub>	Reverse transfer capacitance		-	30	-	pF
Rg	Gate input resistance	f = 1 MHz, I <sub>D</sub> = 0 A	-	2	-	Ω
Qg	Total gate charge		-	73	-	nC
Q <sub>gs</sub>	Gate-source charge	$V_{DD}$ = 400 V, $I_{D}$ = 20 A, $V_{GS}$ = 0 to 20 V	-	14	-	nC
Q <sub>gd</sub>	Gate-drain charge		-	27	-	nC

#### Table 5. Switching energy (inductive load), based on HiP247 package option

Symbol	Parameter	er Test conditions		Тур.	Max.	Unit
E <sub>on</sub>	Turn-on switching energy	V <sub>DD</sub> = 400 V, I <sub>D</sub> = 20 A,	-	100	-	μJ
E <sub>off</sub>	Turn-off switching energy	$\rm R_G$ = 4.7 $\Omega,\rm V_{GS}$ = -5 to 20 V	-	35	-	μJ

#### Table 6. Switching times, based on HiP247 package option

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time		-	16	-	ns
t <sub>f</sub>	Fall time	V <sub>DD</sub> = 400 V, I <sub>D</sub> = 20 A,	-	14	-	ns
t <sub>d(off)</sub>	Turn-off delay time	${\sf R}_{G}$ = 4.7 $\Omega,$ ${\sf V}_{GS}$ = -5 to 20 V	-	35	-	ns
tr	Rise time		-	9	-	ns

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>SD</sub>	Forward on voltage	$V_{GS}$ = 0 V, I <sub>F</sub> = 20 A,	-	3.3	-	V
t <sub>rr</sub>	Reverse recovery time			18	-	ns
Q <sub>rr</sub>	Reverse recovery charge	$V_{DD}$ = 400 V, I <sub>F</sub> = 20 A, di/dt = 1000 A/µs	-	85	-	nC
I <sub>RRM</sub>	Reverse recovery current		-	7	-	А

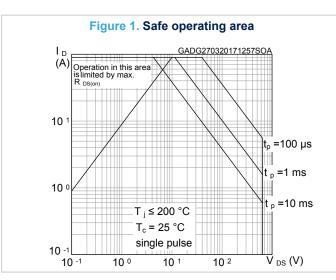
#### Table 7. Reverse diode characteristics, based on HiP247 package option

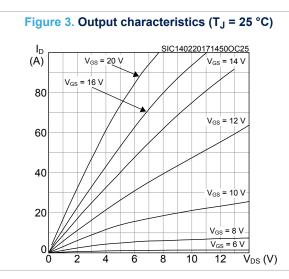
Figure 2. Normalized thermal impedance

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GADG270320171310ZTH

## 2.1 Electrical characteristics (curves), based on HiP247 package option





10<sup>-1</sup> 10<sup>-2</sup> 10<sup>-5</sup> 10<sup>-4</sup> 10<sup>-3</sup> 10<sup>-2</sup> 10<sup>-1</sup> t<sub>p</sub>(s)

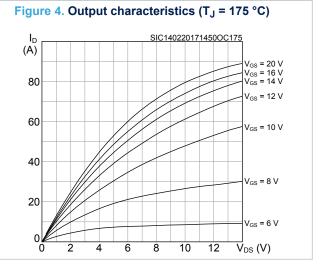
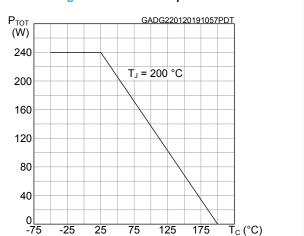
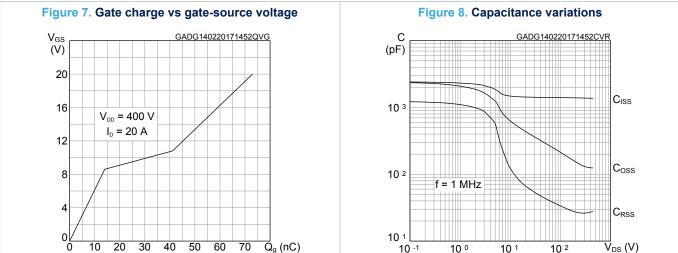


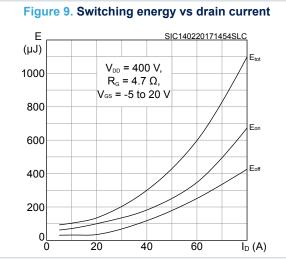
Figure 5. Transfer characteristics Р<sub>тот</sub> (W) GADG140220171450TCH Ι<sub>D</sub> (A) 240 V<sub>DS</sub> = 10 V 80 200 60 160 T<sub>J</sub> = 175 °C 120 40 TJ = 25 °C 80 20 40 0L 0 0L -75 4 8 12 16 V<sub>GS</sub> (V) -25 25 75

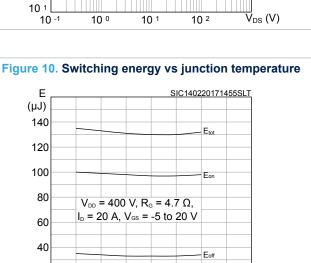
Figure 6. Power dissipation











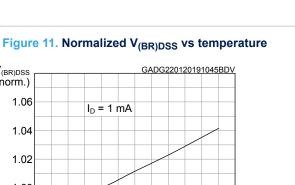


Figure 12. Normalized gate threshold voltage vs temperature

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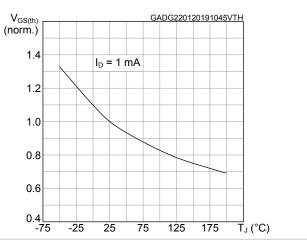
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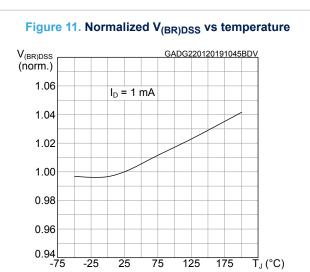
T」(°C)

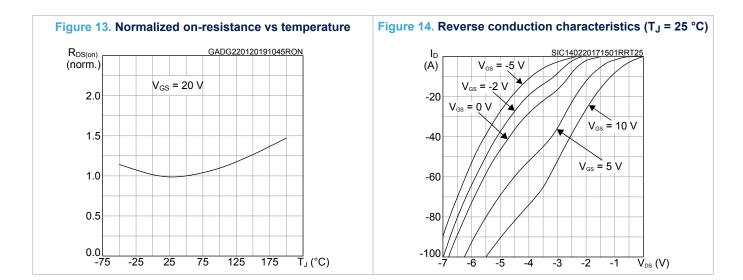
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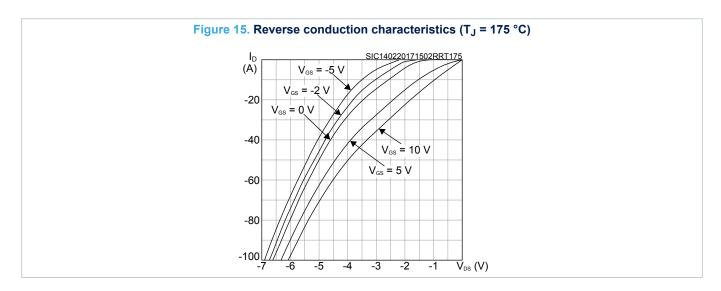
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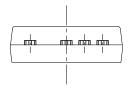
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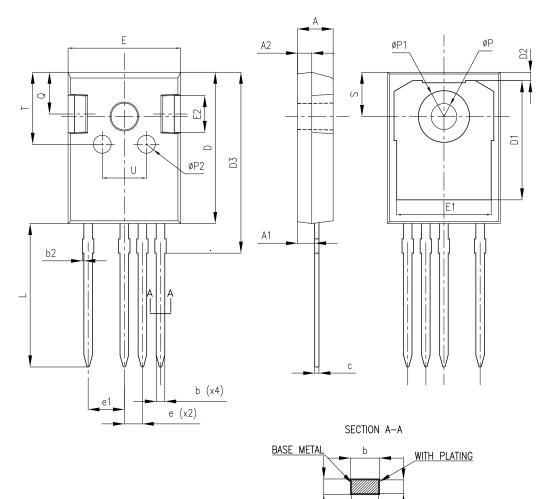
# **3** Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

## 3.1 HiP247-4 package information







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b1

8405626\_2

Table 8.	HiP247-4 mechanical data
	mm

Dim.	mm		
Dini.	Min.	Тур.	Max.
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16		1.29
b1	1.15	1.20	1.25
b2	0		0.20
С	0.59		0.66
c1	0.58	0.60	0.62
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.20	1.35
D3	24.97	25.12	25.27
E	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
е	2.44	2.54	2.64
e1	4.98	5.08	5.18
L	19.80	19.92	20.10
Р	3.50	3.60	3.70
P1			7.40
P2	2.40	2.50	2.60
Q	5.60		6.00
S		6.15	
Т	9.80		10.20
U	6.00		6.40

## **Revision history**

#### Table 9. Document revision history

Date	Version	Changes
02-Dec-2020	1	First release.



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